

DESCRIPTION

This family is a 16M bit dynamic RAM organized 2,097,152 x 8-bit configuration with Fast Page mode CMOS DRAMs. Fast Page mode is a kind of page mode which is useful for the read operation. The circuit and process design allow this device to achieve high performance and low power dissipation. Optional features are access time(60, 70 or 80ns) and refresh cycle(2K ref. or 4K ref.) and power consumption (Normal or Low power with self refresh). Hyundai's advanced circuit design and process technology allow this device to achieve high bandwidth, low power consumption and high reliability.

FEATURES

- Fast Page mode operation
- Read-modify-write Capability
- LVTTTL compatible inputs and outputs
- /CAS-before-/RAS, /RAS-only, Hidden and Self refresh capability
- JEDEC standard pinout
- 28-pin Plastic SOJ (300mil)
28-pin plastic TSOP-II (300mil)
- Single power supply of 3.3V $\pm$ 0.3V
- Early write or output enable controlled write
- Max. Active power dissipation
- Fast access time and cycle time

Speed	2K refresh	4K refresh
60	432mW	360mW
70	360mW	324mW
80	324mW	288mW

Speed	tRAC	tCAC	tPC
60	60ns	15ns	40ns
70	70ns	20ns	45ns
80	80ns	20ns	50ns

- Refresh cycle

Part number	Refresh	Normal	SL-part
HY51V17800B	2K	16ms	256ms
HY51V16800B	4K	64ms	

ORDERING INFORMATION

Part Name	Refresh	Power	Package
HY51V17800CJ	2K		28Pin SOJ
HY51V17800CSLJ	2K	SL-part	28Pin SOJ
HY51V17800CT	2K		28Pin TSOP-II
HY51V17800CSLT	2K	SL-part	28Pin TSOP-II
HY51V16800CJ	4K		28Pin SOJ
HY51V16800CSLJ	4K	SL-part	28Pin SOJ
HY51V16800CT	4K		28Pin TSOP-II
HY51V16800CSLT	4K	SL-part	28Pin TSOP-II

*SL : Low power with self refresh

FUNCTIONAL BLOCK DIAGRAM

*(A10) and *(A11) for 4K refresh part
(2K Refresh / 4K Refresh)*

PIN CONFIGURATION (Marking Side)**28Pin Plastic SOJ (300mil)****28Pin Plastic TSOP- II (300mil)**

*(N.C) : For 2K Refresh product

PIN DESCRIPTION

Pin Name	Parameter
/RAS	Row Address Strobe
/CAS	Column Address Strobe
/WE	Write Enable
/OE	Output Enable
A0~A11	Address Input (4K Refresh Product)
A0~A10	Address Input (2K Refresh Product)
DQ0~DQ7	Data In/Out
Vcc	Power (3.3V)
Vss	Ground
NC	No Connection

ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Rating	Unit
T _A	Ambient Temperature	0 to 70	°C
T _{STG}	Storage Temperature	-55 to 150	°C
V _{IN} , V _{OUT}	Voltage on Any Pin relative to V _{SS}	-0.5 to 4.6	V
V _{CC}	Voltage on V _{CC} relative to V _{SS}	-0.5 to 4.6	V
I _{OS}	Short Circuit Output Current	50	mA
P _D	Power Dissipation	1	W
T _{SOLDER}	Soldering Temperature • Time	260 • 10	°C • sec

Note : Operation at or above Absolute Maximum Ratings can adversely affect device reliability

RECOMMENDED DC OPERATING CONDITIONS

(T_A = 0°C to 70°C)

Symbol	Parameter	Min	Typ	Max	UNIT
V _{CC}	Power Supply Voltage	3.0	3.3	3.6	V
V _{IH}	Input High Voltage	2.0	-	V _{CC} +0.3	V
V _{IL}	Input Low Voltage	-0.3	-	0.8	V

Note : All voltages are referenced to V_{SS}.

DC OPERATING CHARACTERISTIC

Symbol	Parameter	Test condition	Min	Max	Unit
I _{LI}	Input Leakage Current (Any input)	V _{SS} ≤ V _{IN} ≤ V _{CC} + 0.3 All other pins not under test = V _{SS}	-10	10	μA
I _{LO}	Output Leakage Current (Any input)	V _{SS} ≤ V _{OUT} ≤ V _{CC} /RAS & /CAS at V _{IH}	-10	10	μA
V _{OL}	Output Low Voltage	I _{OL} = 2.0mA	-	0.4	V
V _{OH}	Output High Voltage	I _{OH} = -2.0mA	2.4	-	V

DC CHARACTERISTICS

(TA = 0°C to 70°C, VCC = 3.3V ± 0.3V, VSS = 0V, unless otherwise noted.)

Symbol	Parameter	Test condition	Speed	Max. Current		Unit
				2K Ref	4K Ref	
Icc1	Operating Current	/RAS, /CAS Cycling tRC = tRC(min.)	60 70 80	120 100 90	100 90 80	mA
Icc2	LVTTL Standby Current	/RAS, /CAS ≥ VIH Other inputs ≥ VSS	SL-part	2 1	2 1	mA
Icc3	/RAS-only Refresh Current	/RAS Cycling, /CAS = VIH tRC = tRC(min.)	60 70 80	120 100 90	100 90 80	mA
Icc4	Fast Page Mode Current	/CAS Cycling, /RAS = VIL tPC = tPC(min.)	60 70 80	80 70 60	70 60 50	mA
Icc5	CMOS Standby Current	/RAS = /CAS ≥ VCC - 0.2V	SL-part	1 200	1 200	mA mA
Icc6	/CAS-before-/RAS Refresh Current	/RAS & /CAS = 0.2V tRC = tRC(min.)	60 70 80	120 100 90	100 90 80	mA
Icc7	Battery Back-up Current (SL-part)	tRC=250μs (2K Ref), 62.5μs (4K Ref) /CAS = 0.2V /OE & /WE = VCC - 0.2V Address = VCC-0.2V or 0.2V DQ0~DQ7 = VCC-0.2, 0.2V or Open	tRAS ≤ 300ns	300	300	μA
			tRAS ≤ 1μs	400	400	
Icc8	Self Refresh Current (SL-part)	/RAS & /CAS = 0.2V Other pins are same as Icc7		300	300	μA

Note

- Icc1, Icc3, Icc4 and Icc6 depend on output loading and cycle rates(tRC and tPC).
- Specified values are obtained with output unloaded.
- Icc is specified as an average current. In Icc1, Icc3, Icc6, address can be changed only once while /RAS=VIL. In Icc4, address can be changed maximum once while /CAS=VIH within one Fast Page mode cycle time tPC.
- Only /RAS(max.)=1μs is applied to refresh of battery backup but tRAS(max.) = 10 μs is to applied to normal functional operation.
- Icc5(max.) = 200 μA, Icc7 and Icc8 are applied to SL-part only.

AC CHARACTERISTICS

(T_A = 0 °C to 70 °C, V_{CC} = 3.3V ± 0.3V, V_{SS} = 0V, unless otherwise noted.)

Symbol	Parameter	60ns		70ns		80ns		Unit	Note
		Min	Max	Min	Max	Min	Max		
t _{RC}	Random read or write cycle time	110	-	130	-	150	-	ns	
t _{RWC}	Read-modify-write cycle time	155	-	170	-	200	-	ns	
t _{PC}	Fast Page mode cycle time	40	-	45	-	50	-	ns	
t _{PRWC}	Fast Page mode read-modify-write cycle time	80	-	95	-	105	-	ns	
t _{RAC}	Access time from /RAS	-	60	-	70	-	80	ns	4,5,6
t _{CAC}	Access time from /CAS	-	15	-	20	-	20	ns	4,5
t _{AA}	Access time from column address	-	30	-	35	-	40	ns	4,6
t _{CPA}	Access time from /CAS precharge	-	35	-	40	-	45	ns	4
t _{CLZ}	/CAS to output low impedance	0	-	0	-	0	-	ns	4
t _{OFF}	Output buffer turn-off delay from /CAS	0	15	0	15	0	15	ns	7
t _T	Transition time(rise and fall)	3	50	3	50	3	50	ns	2
t _{RP}	/RAS precharge time	40	-	50	-	50	-	ns	
t _{RAS}	/RAS pulse width	60	10K	70	10K	80	10K	ns	
t _{RASP}	/RAS pulse width(Fast Page cycle)	60	100K	70	100K	80	100K	ns	
t _{RSH}	/RAS hold time	15	-	20	-	20	-	ns	
t _{CSH}	/CAS hold time	60	-	70	-	80	-	ns	
t _{CAS}	/CAS pulse width	15	10K	15	10K	20	10K	ns	
t _{RCD}	/RAS to /CAS delay time	20	45	20	50	20	60	ns	5
t _{RAD}	/RAS to column address delay time	15	30	15	35	15	40	ns	6
t _{CRP}	/CAS to /RAS precharge time	5	-	5	-	5	-	ns	10
t _{CP}	/CAS precharge time	10	-	10	-	10	-	ns	14
t _{ASR}	Row address set-up time	0	-	0	-	0	-	ns	
t _{RAH}	Row address hold time	10	-	10	-	10	-	ns	
t _{ASC}	Column address set-up time	0	-	0	-	0	-	ns	
t _{CAH}	Column address hold time	10	-	15	-	15	-	ns	
t _{RAL}	Column address to /RAS lead time	30	-	35	-	40	-	ns	
t _{RCS}	Read command set-up time	0	-	0	-	0	-	ns	
t _{RCH}	Read command hold time referenced to /CAS	0	-	0	-	0	-	ns	8
t _{RRH}	Read command hold time referenced to /RAS	0	-	0	-	0	-	ns	8
t _{WCH}	Write command hold time	15	-	15	-	15	-	ns	
t _{WP}	Write command pulse width	10	-	10	-	10	-	ns	
t _{RWL}	Write command to /RAS lead time	20	-	20	-	20	-	ns	
t _{CWL}	Write command to /CAS lead time	20	-	20	-	20	-	ns	14

AC CHARACTERISTICS

Continued

Symbol	Parameter	60ns		70ns		80ns		Unit	Note
		Min	Max	Min	Max	Min	Max		
tDS	Data-in set-up time	0	-	0	-	0	-	ns	9
tDH	Data-in hold time	15	-	15	-	15	-	ns	9
tREF	Refresh period(2048 cycles)	-	32	-	32	-	32	ms	
	Refresh period(4096 cycles)	-	64	-	64	-	64	ms	
	Refresh period(SL-part)	-	256	-	256	-	256	ms	
tWCS	Write command set-up time	0	-	0	-	0	-	ns	10
tCWD	/CAS to /WE delay time	45	-	50	-	50	-	ns	10,13
tRWD	/RAS to /WE delay time	85	-	95	-	105	-	ns	10
tAWD	Column address to /WE delay time	55	-	60	-	65	-	ns	10
tCSR	/CAS set-up time(CBR cycle)	5	-	5	-	5	-	ns	15
tCHR	/CAS hold time(CBR cycle)	10	-	10	-	10	-	ns	16
tRPC	/RAS to /CAS precharge time	5	-	5	-	5	-	ns	
tCPT	/CAS precharge time(CBR counter test)	30	-	35	-	40	-	ns	12
tROH	/RAS hold time referenced to /OE	10	-	10	-	10	-	ns	
tOEA	/OE access time	-	15	-	20	-	20	ns	
tOED	/OE to data delay Time	15	-	20	-	20	-	ns	
tOEZ	Output buffer turn-off delay time from /OE	0	15	0	15	0	15	ns	7
tOEH	/OE command hold time	15	-	20	-	20	-	ns	
tCPWD	/WE delay time from /CAS precharge	55	-	65	-	75	-	ns	10
tRHCP	/RAS hold time from /CAS precharge	40	-	40	-	50	-	ns	
tWRP	/WE to /RAS precharge time(CBR cycle)	10	-	10	-	10	-	ns	
tWRH	/WE to /RAS hold time(CBR cycle)	10	-	10	-	10	-	ns	
tRASS	/RAS pulse width(self refresh)	100K	-	100K	-	100K	-	ns	
tRPS	/RAS Precharge Time (Self refresh)	110	-	130	-	150	-	ns	
tCHS	/CAS Hold Time (Self refresh)	-50	-	-50	-	-50	-	ns	

NOTE

1. An initial pause of 200 μ s is required after power-up followed by 8 /RAS only refresh cycles before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8 CBR refresh cycles instead of 8 /RAS-only refresh cycles are required.
2. VIH(min.) and VIL(max.) are reference levels for measuring timing of input signals. Transition times are measured between VIH(min.) and VIL(max.)
3. The minimum specifications are used only to indicate cycle time at which proper operation over the full temperature range (TA=0 to 70; $^{\circ}$ C) is assured.
4. Measured at VOH=2.0V and VOL=0.8V with a load equivalent to 1TTL loads and 100pF.
5. Operation within the tRCD(max.) limit ensures that tRAC(max.) can be met. tRCD(max.) is specified as a reference point only. If tRCD is greater than the specified tRCD(max.) limit, then access time is controlled by tCAC.
6. Operation within the tRAD(max.) limit ensures that tRAC(max.) can be met. tRAD(max.) is specified as a reference point only. If tRAD is greater than the specified tRAD(max.) limit, then access time is controlled by tAA.
7. tOFF and tOEZ define the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
8. Either tRCH or tRRH must be satisfied for a read cycle.
9. These parameters are referenced to /CAS leading edge in early write cycles and to /WE leading edge in read-modify-write cycles and late write cycle.
10. twCS, tRWD, tCWD, tAWD and tCPWD are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only. If twCS $\geq$ twCS(min.), the cycle is an early write cycle and data out pin will remain open circuit (high impedance) through the entire cycle. If tRWD $\geq$ tRWD(min.), tCWD $\geq$ tCWD(min.), tAWD $\geq$ tAWD(min.), and tCPWD $\geq$ tCPWD(min.), the cycle is a read-modify-write cycle and data out will contain data read from the selected cell. If neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
11. tASC, tCAH are referenced to the earlier /CAS falling edge.
12. tCP and tCPT are measured when /CAS is high state.
13. tCWD is referenced to the later /CAS falling edge at word read-modify-write cycle.
14. tCWL must be satisfied by /CAS for 8-bit access cycles.
15. tCSR is referenced to the earlier /CAS falling before /RAS transition low.
16. tCHR is referenced to the later /CAS rising high after /RAS transition low.

CAPACITANCE

(TA = 25 $^{\circ}$ C, VCC = 3.3V $\pm$ 0.3V, VSS = 0V and f=1MHz, unless otherwise noted.)

Symbol	Parameter	Typ.	Max	Unit
CIN1	Input Capacitance (A0~A11)	-	5	pF
CIN2	Input Capacitance (/RAS, /CAS, /WE, /OE)	-	7	pF
CDQ	Data Input / Output Capacitance (DQ0~DQ7)	-	7	pF